

<b>PATENT ASSIGNMENT COVER SHEET</b>
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EPAS ID: PAT6487663

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
DEAN SANDERS	06/29/2016
STU STATMAN	06/29/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SUNVERGE ENERGY, INC.
<b>Street Address:</b>	950 MINNA STREET
<b>City:</b>	SAN FRANCISCO
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	94103
<b>PROPERTY NUMBERS Total: 2</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16848082
<b>Application Number:</b>	16848084
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	52416.28US08 & 28US09
<b>NAME OF SUBMITTER:</b>	GARY J. EDWARDS
<b>SIGNATURE:</b>	/Gary J. Edwards/
<b>DATE SIGNED:</b>	01/08/2021
<b>Total Attachments: 3</b>	
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source=52416.28US08 & 28US09 Assignment Signed#page2.tif	
source=52416.28US08 & 28US09 Assignment Signed#page3.tif	

**ASSIGNMENT**

**WHEREAS, WE,**

(1) Stu STATMAN of San Francisco, California, USA

(2) Dean SANDERS of Linden, California, USA

have invented certain improvements in:

**RENEWABLE ENERGY INTEGRATED STORAGE  
AND GENERATION SYSTEMS, APPARATUS, AND METHODS  
WITH CLOUD DISTRIBUTED ENERGY MANAGEMENT SERVICES**

for which:

WE have filed an application for Letters Patent of the United States of America on July 4, 2015, as Application Serial No. 14/791,420; and

**WHEREAS, SUNVERGE ENERGY, INC.** ("Assignee"), a corporation organized and existing under the laws of the State of Delaware, having its principal office and place of business at 950 Minna Street in the City of San Francisco, State of California, 94103 is desirous of obtaining the entire right, title, and interest in, to and under said invention and said application in the United States of America and in any and all countries foreign thereto;

**NOW, THEREFORE,** for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto said Assignee, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under said invention, and said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue

all Letters Patent for said invention to said Assignee, its successors, legal representatives and assigns, in accordance with the terms of this instrument.


AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said Assignee, its successors, legal representatives and assigns, any facts known to we respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said Assignee, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

First Inventor Name: Dean SANDERS

Residence Address: 5388 Ryburn Way  
Linden, California 95236

Dated: 06/29/2016

  
Inventor Signature

Second Inventor Name: Stu STATMAN

Residence Address: 775 Post Street, # 310  
San Francisco, California 94109

Dated: \_\_\_\_\_

\_\_\_\_\_  
Inventor Signature

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First Inventor Name: Stu STATMAN

Residence Address: 775 Post Street, # 310  
San Francisco, California 94109

Dated: 6/22/2016

[Signature]  
Inventor Signature

Second Inventor Name: Dean SANDERS

Residence Address: 5388 Ryburn Way  
Linden, California 95236

Dated: \_\_\_\_\_

\_\_\_\_\_  
Inventor Signature

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